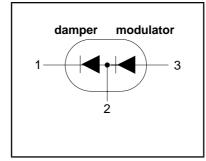
BYM357X

FEATURES

- Low forward volt drop

- Fast switching
 Soft recovery characteristic
 High thermal cycling performance
- Isolated mounting tab

SYMBOL



QUICK REFERENCE DATA

DAMPER	MODULATOR
V _R =1500 V	V _R =600 V
$V_F \le 1.3 \text{ V}$	V _F ≤ 1.03 V
I _{F(peak)} =7 A	$I_{F(peak)} = 7 A$
I _{FSM} ≤ 60 A	I _{FSM} ≤ 70 A
t _{rr} ≤ 300 ns	t _{rr} ≤ 60 ns

GENERAL DESCRIPTION

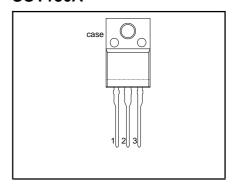
Combined damper and modulator diodes in an isolated plastic envelope for horizontal deflection in colour TV and PC monitors. The BYM357X contains diodes with performance characteristics designed specifically for applications from 16kHz to 70kHz

The BYM357X series is supplied in the conventional leaded SOT186A package.

PINNING

PIN	DESCRIPTION
1	damper cathode
2	common anode/cathode
3	modulator anode.

SOT186A



LIMITING VALUES

 $T_i = 25$ °C unless otherwise stated

			DAM	IPER	MODU	LATOR	
SYMBOL	PARAMETER	CONDITIONS	MIN	MAX	MIN	MAX	UNIT
V_{RSM}	Peak non-repetitive reverse voltage.		-	1500	-	600	V
V_{RRM}	Peak repetitive reverse voltage		-	1500	-	600	V
V_{RWM}	Crest working reverse voltage		-	1300	-	600	V
I _{F(peak)}	Peak forward current	31-70 kHz monitor.	-	7	-	7	Α
I _{F(RMS)}	RMS forward current	sinusoidal;a=1.57	-	15.7	-	14.1	Α
I _{FSM}	Peak non-repetitive forward current	$ t = 10 \text{ ms} \\ t = 8.3 \text{ ms} \\ \text{sinusoidal;with} \\ \text{reapplied} \\ V_{\text{RWM(MAX)}} $	-	60 66	-	70 77	A A
${\mathsf T}_{stg} \ {\mathsf T}_{\mathsf J}$	Storage temperature Operating junction temperature		-40 -	150 150	-40 -	150 150	°C C

Philips Semiconductors Product specification

Damper-Modulator fast, high-voltage

BYM357X

ISOLATION LIMITING VALUE & CHARACTERISTIC

 T_{hs} = 25 $^{\circ}C$ unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	R.M.S. isolation voltage from all three terminals to external heatsink	f = 50-60 Hz; sinusoidal waveform; R.H. ≤ 65%; clean and dustfree	-	1	2500	V
C _{isol}	Capacitance from T2 to external heatsink	f = 1 MHz	-	10	-	pF

THERMAL RESISTANCES

			DAM	IPER	MODU	LATOR	
SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	TYP.	MAX.	UNIT
R _{th j-hs}	Thermal resistance junction to heatsink	with heatsink compound	-	4.8	-	5.5	K/W
R _{th j-a}	Thermal resistance junction to ambient	in free air.	55	-	55	-	K/W

STATIC CHARACTERISTICS OF DAMPER

T_i = 25 °C unless otherwise stated

.,					
SYMBOL	PARAMETER	CONDITIONS	TYP	MAX.	UNIT
V _F	Forward voltage	I _F = 6.5 A I _F = 6.5 A; T _i = 125°C	1.1 1.05	1.45 1.3	V
I _R	Reverse current	$V_R = V_{RWM}$ $V_R = V_{RWM}$ $T_i = 100 ^{\circ}C$	10 50	250 500	μA μA

STATIC CHARACTERISTICS OF MODULATOR

 $T_i = 25$ °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	TYP	MAX.	UNIT
V _F	Forward voltage	I _F = 8 A I _F = 8 A; T _j = 125°C I _F = 20 A	1.05 0.9 1.3	1.25 1.03 1.45	V V
I _R	Reverse current.		10 100	50 350	μA μA

BYM357X

ELECTRICAL CHARACTERISTICS OF DAMPER

 $T_i = 25$ °C unless otherwise stated

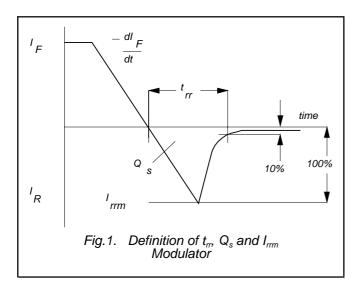
SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
t _{rr}	Reverse recovery time	$I_F = 1 \text{ A}; V_R \ge 30 \text{ V};$ - $dI_F/dt = 50 \text{ A/}\mu\text{s}$	200	300	ns
$egin{array}{c} Q_s \ V_{fr} \end{array}$	Reverse recovery charge Peak forward recovery voltage	2 A,30 V,20 A/µs $I_F = 6.5 \text{ A;}$ $dI_F/dt = 50 \text{ A/µs}$	1.2 27	2.0	μC V

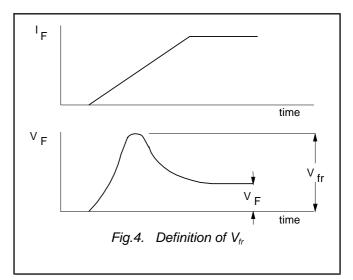
ELECTRICAL CHARACTERISTICS OF MODULATOR

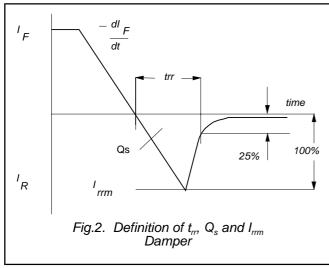
T_i = 25 °C unless otherwise stated

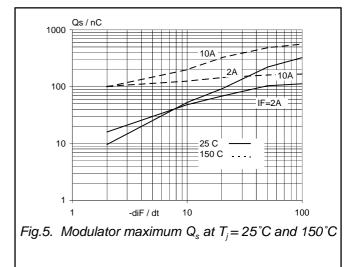
SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
t _{rr}	Reverse recovery time	$I_F = 1 \text{ A}; V_R \ge 30 \text{ V};$ - $dI_F/dt = 100 \text{ A/}\mu\text{s}$	35	60	ns
I _{rrm}	Peak reverse recovery current	$I_F = 10 \text{ A to V}_R \ge 30 \text{ V};$ $dI_F/dt = 50 \text{ A/}\mu\text{s}; T_i = 100^{\circ}\text{C}$	3.0	5.5	Α
$egin{array}{c} Q_s \ V_{fr} \end{array}$	Reverse recovery charge Peak forward recovery voltage	$2 \text{ A},30 \text{ V},20 \text{ A}/\mu\text{s}$ $I_F = 10 \text{ A};$ $dI_F/dt = 10 \text{ A}/\mu\text{s}$	40 3.2	70 -	nC V

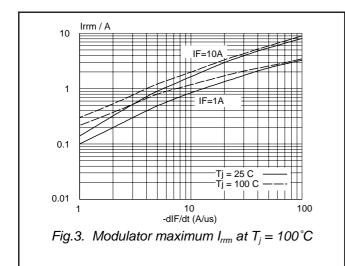
BYM357X

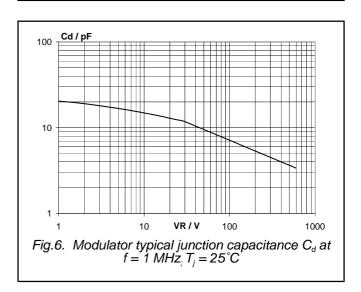




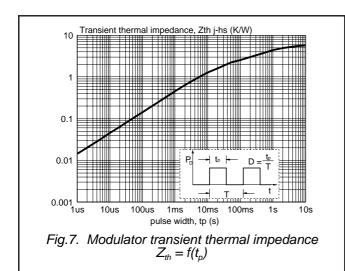








BYM357X



0.01
0.01
0.001
0.001
1us 10us 10us 1ms 10ms 100ms 1s 10s pulse width, tp (s)

Fig. 10. Damper transient thermal impedance $Z_{th} = f(t_p)$

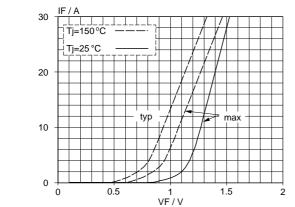


Fig.8. Modulator typical and maximum forward characteristic; $I_F = f(V_F)$; parameter T_i

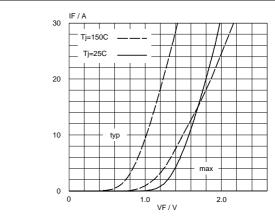


Fig.11. Damper forward characteristic $I_F = f(V_F)$; parameter T_i

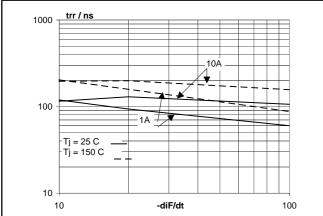
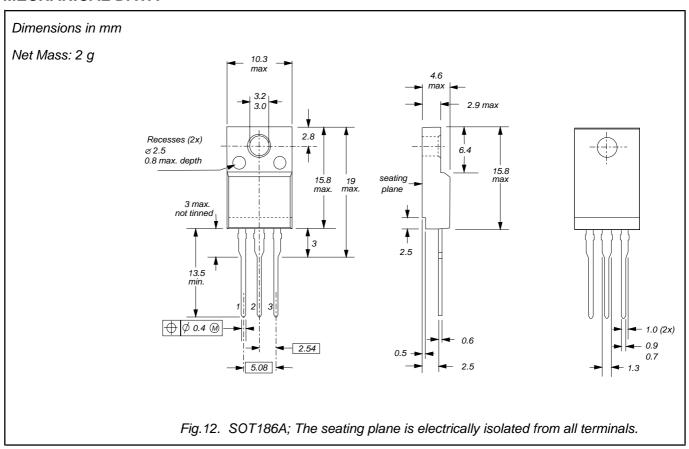


Fig.9. Modulator maximum t_{rr} measured to 25% of I_{rrm} ; $T_j = 25^{\circ}\text{C}$ and 150°C

BYM357X

MECHANICAL DATA



- Notes
 1. Refer to mounting instructions for F-pack envelopes.
 2. Epoxy meets UL94 V0 at 1/8".

Philips Semiconductors Product specification

Damper-Modulator fast, high-voltage

BYM357X

DEFINITIONS

Data sheet status					
Objective specification	This data sheet contains target or goal specifications for product development.				
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.				
Product specification	This data sheet contains final product specifications.				
Limiting values					

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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